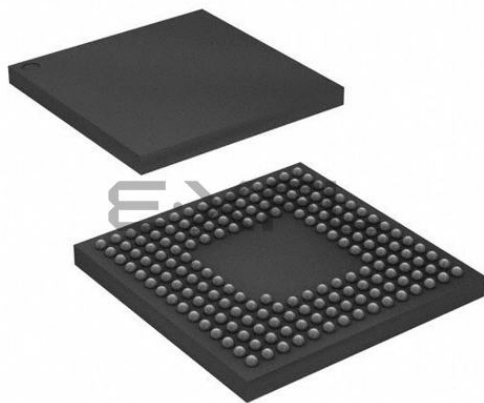




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Details

Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	133
Program Memory Size	768KB (768K x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 21x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	177-TFLGA
Supplier Device Package	177-TFLGA (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631addlc-u0

Table 1.1 Outline of Specifications (3/6)

Classification	Module/Function	Description
I/O ports	General I/O ports	- I/O ports for the 177-pin TFLGA, 176-pin LFBGA and 176-pin LQFP I/O pins: 133 Input pins: 1 Pull-up resistors: 133 Open-drain outputs: 133 5-V tolerance: 18 - I/O ports for the 145-pin TFLGA and 144-pin LQFP I/O pins: 111 Input pins: 1 Pull-up resistors: 111 Open-drain outputs: 111 5-V tolerance: 18 - I/O ports for the 100-pin TFLGA (in the planning stage) and 100-pin LQFP I/O pins: 78 Input pins: 1 Pull-up resistors: 78 Open-drain outputs: 78 5-V tolerance: 17 - I/O ports for the 64-pin TFLGA I/O pins: 39 Input pin: 1 Pull-up resistors: 39 Open-drain outputs: 39 5-V tolerance: 8 - I/O ports for the 64-pin LQFP I/O pins: 42 Input pin: 1 Pull-up resistors: 42 Open-drain outputs: 42 5-V tolerance: 8 8-bit port switching function - I/O ports for the 48-pin LQFP I/O pins: 30 Input pin: 1 Pull-up resistors: 30 Open-drain outputs: 30 5-V tolerance: 6 8-bit port switching function

Table 1.3 List of Products (7/8)

Group	Part No.	Package	ROM Capacity	RAM Capacity	E2 Data Flash	Operating Frequency (Max.)	Operating Temp. Range
RX631 (D version)	R5F5631NDDFM	PLQP0064KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631MCDFM	PLQP0064KB-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631MDDFM	PLQP0064KB-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631PCDFL	PLQP0048KB-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631PDDFL	PLQP0048KB-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631NCDFL	PLQP0048KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631NDDFL	PLQP0048KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631MCDFL	PLQP0048KB-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631MDDFL	PLQP0048KB-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56318SDLC	PTLG0177KA-A	512 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56317SDLC	PTLG0177KA-A	384 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56316SDLC	PTLG0177KA-A	256 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56318SDBG	PLBG0176GA-A*1	512 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56317SDBG	PLBG0176GA-A*1	384 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56316SDBG	PLBG0176GA-A*1	256 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56318SDFC	PLQP0176KB-A*1	512 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56317SDFC	PLQP0176KB-A*1	384 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56316SDFC	PLQP0176KB-A*1	256 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56318SDLK	PTLG0145KA-A	512 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56317SDLK	PTLG0145KA-A	384 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56316SDLK	PTLG0145KA-A	256 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56318SDFB	PLQP144KA-A*1	512 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56317SDFB	PLQP144KA-A*1	384 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F56316SDFB	PLQP144KA-A*1	256 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631PFDLH	PTLG0064JA-A	512 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631MFDLH	PTLG0064JA-A*1	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5S56310CDFC	PLQP0176KB-A	0 bytes	128 Kbytes	0 bytes	100 MHz	-40 to +85°C
RX631 (G version) *2	R5F5631FDGFC	PLQP0176KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631KDGFC	PLQP0176KB-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631EDGFC	PLQP0176KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631DDGFC	PLQP0176KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631YDGFC	PLQP0176KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631WDGFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631BDGFC	PLQP0176KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631ADGFC	PLQP0176KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F56318SGFC	PLQP0176KB-A	512 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F56318DGFC	PLQP0176KB-A	512 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F56317SGFC	PLQP0176KB-A	384 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F56317DGFC	PLQP0176KB-A	384 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F56316SGFC	PLQP0176KB-A	256 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F56316DGFC	PLQP0176KB-A	256 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631FDGFB	PLQP0144KA-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631KDGFB	PLQP0144KA-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631EDGFB	PLQP0144KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F5631JDGFB	PLQP0144KA-A	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C

Table 1.4 Pin Functions (4/6)

Classifications	Pin Name	I/O	Description
Serial communications interface (SCId)	• Asynchronous mode/clock synchronous mode		
	SCK12	I/O	Input/output pin for clock signals.
	RXD12	Input	Input pin for data reception.
	TXD12	Output	Output pin for data transmission.
	CTS12#	Input	Transmit/receive start control input pins
	RTS12#	Output	Transmit/receive start control output pins
	• Simple I ² C mode		
	SSCL12	I/O	Input/output pins for the I ² C clock
	SSDA12	I/O	Input/output pins for the I ² C data
	• Simple SPI mode		
	SCK12	I/O	Input/output pins for the clock
	SMISO12	I/O	Input/output pins for slave transmit data.
	SMOSI12	I/O	Input/output pins for master transmit data.
	SS12#	Input	Input pins for chip select signals
	• Extended serial mode		
	RXDX12	Input	Input pin for receive data
	TXDX12	Output	Output pin for transmit data
	SIOX12	I/O	Input/output pin for Transmit/receive data
I ² C bus interface	SCL0[FM+], SCL1 to SCL3	I/O	Input/output pin for clocks. Bus can be directly driven by the N-channel open drain output.
	SDA0[FM+], SDA1 to SDA3	I/O	Input/output pin for data. Bus can be directly driven by the N-channel open drain output.
Ethernet controller	REF50CK	Input	50-MHz reference clock. This pin inputs reference signals for transmission/reception timings in RMII mode.
	RMII_CRS_DV	Input	Indicates that there are carrier detection signals and valid receive data on RMII_RXD1 and RMII_RXD0 in RMII mode.
	RMII_TXD0, RMII_TXD1	Output	2-bit transmit data in RMII mode.
	RMII_RXD0, RMII_RXD1	Input	2-bit receive data in RMII mode.
	RMII_TXD_EN	Output	Output pin for data transmit enable signals in RMII mode.
	RMII_RX_ER	Input	Indicates an error has occurred during reception of data in RMII mode.
	ET_CRS	Input	Carrier detection/data reception enable pin.
	ET_RX_DV	Input	Indicates that there are valid receive data on ET_ERXD3 to ET_ERXD0.
	ET_EXOUT	Output	General-purpose external output pin.
	ET_LINKSTA	Input	Inputs link status from the PHY-LSI.
	ET_ETXD0 to ET_ETXD3	Output	4 bits of MII transmit data.
	ET_ERXD0 to ET_ERXD3	Input	4 bits of MII receive data.
	ET_TX_EN	Output	Transmit enable pin. Indicates that transmit data is ready on ET_ETXD3 to ET_ETXD0.
	ET_TX_ER	Output	Transmit error pin. Notifies the PHY_LSI of an error during transmission.
	ET_RX_ER	Input	Receive error pin. Recognizes an error during reception.
	ET_TX_CLK	Input	Transmit clock pin. This pin inputs reference signals for output timings from ET_TX_EN, ET_ETXD3 to ET_ETXD0, and ET_TX_ER.
	ET_RX_CLK	Input	Receive clock pin. This pin inputs reference signals for input timings to ET_RX_DV, ET_ERXD3 to ET_ERXD0, and ET_RX_ER.
	ET_COL	Input	Inputs collision detection signals.
	ET_WOL	Output	Receives Magic packets.
	ET_MDC	Output	Outputs reference clock signals for information transfer via ET_MDIO.

Table 1.12 List of Pins and Pin Functions (64-Pin LQFP) (2/3)

Pin Number 64-Pin LQFP	Power Supply Clock System Control	I/O Port	Timer (MTU2a, TPUa, TMR, PPG, RTCa, POE2a)	Timer Communications (SC1c, SC1d, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12ADa, DAa
32		PC2	MTIOC4B/TCLKA/ PO21	RXD5/SMISO5/SSCL5/ SSLA3/IERXD		
33		PB7/ PC1	MTIOC3B/TIOCB5/ PO31	TXD9/SMOSI9/SSDA9		
34		PB6/ PC0	MTIOC3D/TIOCA5/ PO30	RXD9/SMISO9/SSCL9		
35		PB5	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE1#	SCK9		
36		PB3	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/TMO0/ PO27/POE3#	SCK6		
37		PB1	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD6/SMOSI6/SSDA6	IRQ4-DS	
38	VCC					
39		PB0	MTIC5W/TIOCA3/PO24	RXD6/SMISO6/SSCL6/ RSPCKA	IRQ12	
40	VSS					
41		PA6	MTIC5V/MTCLKB/ TIOCA2/TMCI3/PO22/ POE2#	CTS5#/RTS5#/SS5#/ MOSIA		
42		PA4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0	IRQ5-DS	
43		PA3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/SSCL5	IRQ6-DS	
44		PA1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2/SCL2	IRQ11	
45		PA0	MTIOC4A/TIOCA0/ PO16	SSLA1		
46		PE5	MTIOC4C/MTIOC2B	RSPCKB	IRQ5	AN013
47		PE4	MTIOC4D/MTIOC1A/ PO28	SSLB0		AN012
48		PE3	MTIOC4B/PO26/POE8#	CTS12#/RTS12#/ SS12#/MISOB		AN011
49		PE2	MTIOC4A/PO23	RXD12/SMISO12/ SSCL12/RXDX12/ SSLB3/MOSIB	IRQ7-DS	AN010
50		PE1	MTIOC4C/PO18	TXD12/SMOSI12/SSDA12/ TXDX12/SIOX12/SSLB2/ RSPCKB		AN009
51		PE0		SCK12/SSLB1		AN008
52	VREFL					
53		P46			IRQ14-DS	AN006
54	VREFH					
55		P44			IRQ12-DS	AN004
56		P43			IRQ11-DS	AN003
57		P42			IRQ10-DS	AN002
58		P41			IRQ9-DS	AN001
59	VREFL0					
60		P40			IRQ8-DS	AN000

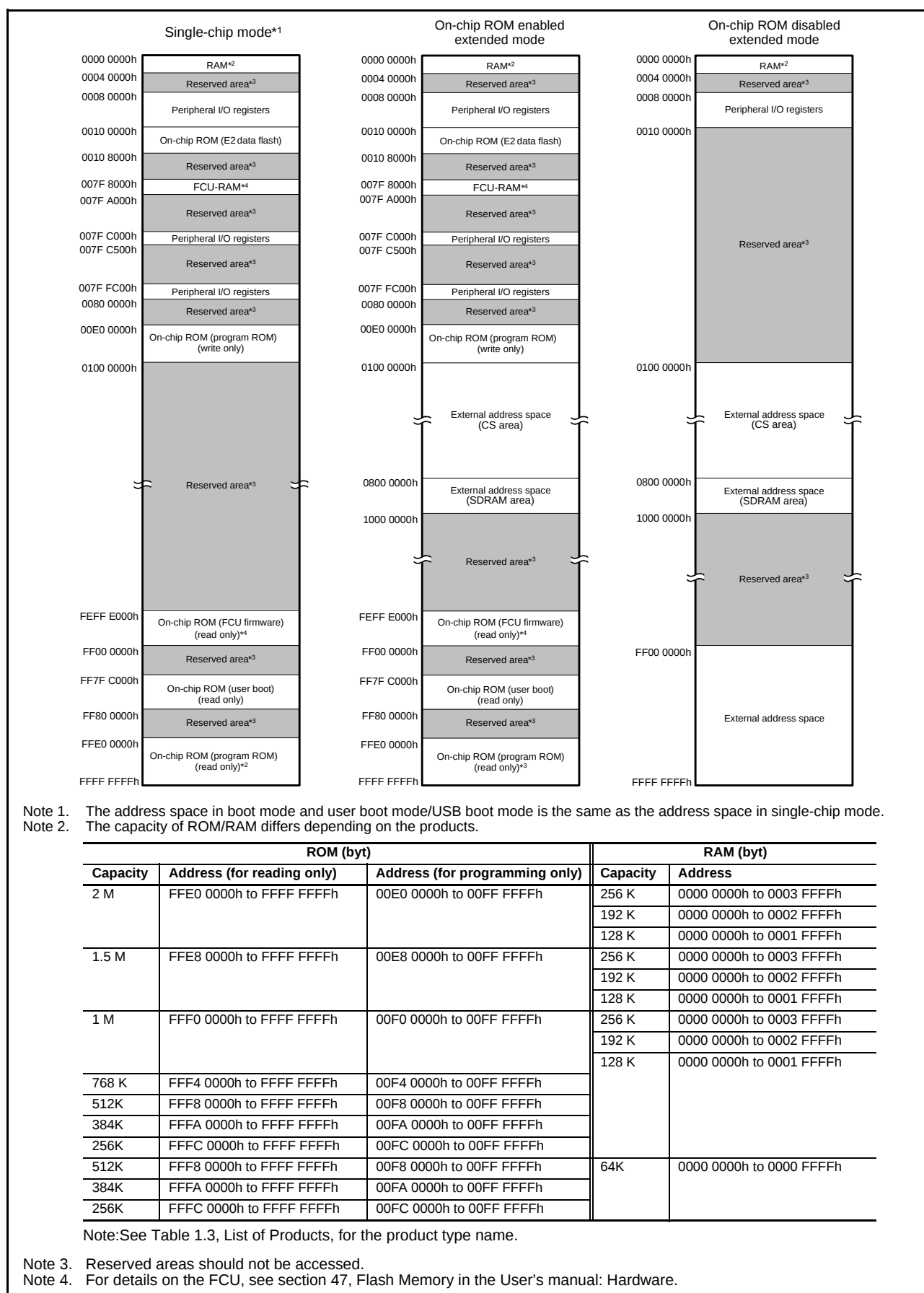


Figure 3.1 Memory Map in Each Operating Mode

- Longword-size I/O registers

```
MOV.L #SFR_ADDR, R1
MOV.L #SFR_DATA, [R1]
CMP [R1].L, R1
;; Next process
```

If multiple registers are written to and a subsequent instruction should be executed after the write operations are entirely completed, only read the I/O register that was last written to and execute the operation using the value; it is not necessary to read or execute operation for all the registers that were written to.

(3) Number of Access Cycles to I/O Registers

For the number of I/O register access cycles, refer to Table 4.1, List of I/O Registers (Address Order).

The number of access cycles to I/O registers is obtained by following equation.*1

$$\begin{aligned} \text{Number of access cycles to I/O registers} = & \text{Number of bus cycles for internal main bus 1} + \\ & \text{Number of divided clock synchronization cycles} + \\ & \text{Number of bus cycles for internal peripheral busses 1 to 6} \end{aligned}$$

The number of bus cycles of internal peripheral bus 1 to 6 differs according to the register to be accessed.

When peripheral functions connected to internal peripheral bus 2 to 6 or registers for the external bus control unit (except for bus error related registers) are accessed, the number of divided clock synchronization cycles is added.

The number of divided clock synchronization cycles differs depending on the frequency ratio between ICLK and PCLK (or FCLK, BCLK) or bus access timing.

In the peripheral function unit, when the frequency ratio of ICLK is equal to or greater than that of PCLK (or FCLK), the sum of the number of bus cycles for internal main bus 1 and the number of the divided clock synchronization cycles will be one cycle of PCLK (or FCLK) at a maximum. Therefore, one PCLK (or FCLK) has been added to the number of access states shown in Table 4.1.

When the frequency ratio of ICLK is lower than that of PCLK (or FCLK), the subsequent bus access is started from the ICLK cycle following the completion of the access to the peripheral functions. Therefore, the access cycles are described on an ICLK basis.

In the external bus control unit, the sum of the number of bus cycles for internal main bus 1 and the number of divided clock synchronization cycles will be one cycle of BCLK at a maximum. Therefore, one BCLK is added to the number of access cycles shown in Table 4.1.

Note 1. This applies to the number of cycles when the access from the CPU does not conflict with the instruction fetching to the external memory or bus access from the different bus master (DMAC or DTC).

(4) Restrictions in Relation to RMPA and String-Manipulation Instructions

The allocation of data to be handled by RMPA or string-manipulation instructions to I/O registers is prohibited, and operation is not guaranteed if this restriction is not observed.

Table 4.1 List of I/O Registers (Address Order) (2/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 201Ch	DMAC0	DMA transfer enable register	DMCNT	8	8	2	ICLK	DMACA
0008 201Dh	DMAC0	DMA software start register	DMREQ	8	8	2	ICLK	
0008 201Eh	DMAC0	DMA status register	DMSTS	8	8	2	ICLK	
0008 201Fh	DMAC0	DMA activation source flag control register	DMCSL	8	8	2	ICLK	
0008 2040h	DMAC1	DMA source address register	DMSAR	32	32	2	ICLK	
0008 2044h	DMAC1	DMA destination address register	DMDAR	32	32	2	ICLK	
0008 2048h	DMAC1	DMA transfer count register	DMCRA	32	32	2	ICLK	
0008 204Ch	DMAC1	DMA block transfer count register	DMCRB	16	16	2	ICLK	
0008 2050h	DMAC1	DMA transfer mode register	DMTMD	16	16	2	ICLK	
0008 2053h	DMAC1	DMA interrupt setting register	DMINT	8	8	2	ICLK	
0008 2054h	DMAC1	DMA address mode register	DMAMD	16	16	2	ICLK	
0008 205Ch	DMAC1	DMA transfer enable register	DMCNT	8	8	2	ICLK	
0008 205Dh	DMAC1	DMA software start register	DMREQ	8	8	2	ICLK	
0008 205Eh	DMAC1	DMA status register	DMSTS	8	8	2	ICLK	
0008 205Fh	DMAC1	DMA activation source flag control register	DMCSL	8	8	2	ICLK	
0008 2080h	DMAC2	DMA source address register	DMSAR	32	32	2	ICLK	
0008 2084h	DMAC2	DMA destination address register	DMDAR	32	32	2	ICLK	
0008 2088h	DMAC2	DMA transfer count register	DMCRA	32	32	2	ICLK	
0008 208Ch	DMAC2	DMA block transfer count register	DMCRB	16	16	2	ICLK	
0008 2090h	DMAC2	DMA transfer mode register	DMTMD	16	16	2	ICLK	
0008 2093h	DMAC2	DMA interrupt setting register	DMINT	8	8	2	ICLK	
0008 2094h	DMAC2	DMA address mode register	DMAMD	16	16	2	ICLK	
0008 209Ch	DMAC2	DMA transfer enable register	DMCNT	8	8	2	ICLK	
0008 209Dh	DMAC2	DMA software start register	DMREQ	8	8	2	ICLK	
0008 209Eh	DMAC2	DMA status register	DMSTS	8	8	2	ICLK	
0008 209Fh	DMAC2	DMA activation source flag control register	DMCSL	8	8	2	ICLK	
0008 20C0h	DMAC3	DMA source address register	DMSAR	32	32	2	ICLK	EXDMACa
0008 20C4h	DMAC3	DMA destination address register	DMDAR	32	32	2	ICLK	
0008 20C8h	DMAC3	DMA transfer count register	DMCRA	32	32	2	ICLK	
0008 20CCh	DMAC3	DMA block transfer count register	DMCRB	16	16	2	ICLK	
0008 20D0h	DMAC3	DMA transfer mode register	DMTMD	16	16	2	ICLK	
0008 20D3h	DMAC3	DMA interrupt setting register	DMINT	8	8	2	ICLK	
0008 20D4h	DMAC3	DMA address mode register	DMAMD	16	16	2	ICLK	
0008 20DCh	DMAC3	DMA transfer enable register	DMCNT	8	8	2	ICLK	
0008 20DDh	DMAC3	DMA software start register	DMREQ	8	8	2	ICLK	
0008 20DEh	DMAC3	DMA status register	DMSTS	8	8	2	ICLK	
0008 20DFh	DMAC3	DMA activation source flag control register	DMCSL	8	8	2	ICLK	
0008 2200h	DMAC	DMACA module activation register	DMAST	8	8	2	ICLK	
0008 2400h	DTC	DTC control register	DTCCR	8	8	2	ICLK	DTCa
0008 2404h	DTC	DTC vector base register	DTCVBR	32	32	2	ICLK	
0008 2408h	DTC	DTC address mode register	DTCADMOD	8	8	2	ICLK	
0008 240Ch	DTC	DTC module start register	DTCST	8	8	2	ICLK	
0008 240Eh	DTC	DTC status register	DTCSTS	16	16	2	ICLK	
0008 2800h	EXDMAC0	EXDMA source address register	EDMSAR	32	32	1, 2	BCLK	EXDMACa
0008 2804h	EXDMAC0	EXDMA destination address register	EDMDAR	32	32	1, 2	BCLK	
0008 2808h	EXDMAC0	EXDMA transfer count register	EDMCRA	32	32	1, 2	BCLK	
0008 280Ch	EXDMAC0	EXDMA block transfer count register	EDMCRB	16	16	1, 2	BCLK	
0008 2810h	EXDMAC0	EXDMA transfer mode register	EDMTMD	16	16	1, 2	BCLK	
0008 2812h	EXDMAC0	EXDMA output setting register	EDMOMD	8	8	1, 2	BCLK	
0008 2813h	EXDMAC0	EXDMA interrupt setting register	EDMINT	8	8	1, 2	BCLK	
0008 2814h	EXDMAC0	EXDMA address mode register	EDMAMD	32	32	1, 2	BCLK	

Table 4.1 List of I/O Registers (Address Order) (6/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 7047h	ICU	Interrupt request register 071	IR071	8	8	2	ICLK	ICUb
0008 7048h	ICU	Interrupt request register 072	IR072	8	8	2	ICLK	
0008 7049h	ICU	Interrupt request register 073	IR073	8	8	2	ICLK	
0008 704Ah	ICU	Interrupt request register 074	IR074	8	8	2	ICLK	
0008 704Bh	ICU	Interrupt request register 075	IR075	8	8	2	ICLK	
0008 704Ch	ICU	Interrupt request register 076	IR076	8	8	2	ICLK	
0008 704Dh	ICU	Interrupt request register 077	IR077	8	8	2	ICLK	
0008 704Eh	ICU	Interrupt request register 078	IR078	8	8	2	ICLK	
0008 704Fh	ICU	Interrupt request register 079	IR079	8	8	2	ICLK	
0008 705Ah	ICU	Interrupt request register 090	IR090	8	8	2	ICLK	
0008 705Bh	ICU	Interrupt request register 091	IR091	8	8	2	ICLK	
0008 705Ch	ICU	Interrupt request register 092	IR092	8	8	2	ICLK	
0008 705Dh	ICU	Interrupt request register 093	IR093	8	8	2	ICLK	
0008 7062h	ICU	Interrupt request register 098	IR098	8	8	2	ICLK	
0008 7066h	ICU	Interrupt request register 102	IR102	8	8	2	ICLK	
0008 706Ah	ICU	Interrupt request register 106	IR106	8	8	2	ICLK	
0008 706Bh	ICU	Interrupt request register 107	IR107	8	8	2	ICLK	
0008 706Ch	ICU	Interrupt request register 108	IR108	8	8	2	ICLK	
0008 706Dh	ICU	Interrupt request register 109	IR109	8	8	2	ICLK	
0008 706Eh	ICU	Interrupt request register 110	IR110	8	8	2	ICLK	
0008 706Fh	ICU	Interrupt request register 111	IR111	8	8	2	ICLK	
0008 7070h	ICU	Interrupt request register 112	IR112	8	8	2	ICLK	
0008 7072h	ICU	Interrupt request register 114	IR114	8	8	2	ICLK	
0008 707Ah	ICU	Interrupt request register 122	IR122	8	8	2	ICLK	
0008 707Bh	ICU	Interrupt request register 123	IR123	8	8	2	ICLK	
0008 707Ch	ICU	Interrupt request register 124	IR124	8	8	2	ICLK	
0008 707Dh	ICU	Interrupt request register 125	IR125	8	8	2	ICLK	
0008 707Eh	ICU	Interrupt request register 126	IR126	8	8	2	ICLK	
0008 707Fh	ICU	Interrupt request register 127	IR127	8	8	2	ICLK	
0008 7080h	ICU	Interrupt request register 128	IR128	8	8	2	ICLK	
0008 7081h	ICU	Interrupt request register 129	IR129	8	8	2	ICLK	
0008 7082h	ICU	Interrupt request register 130	IR130	8	8	2	ICLK	
0008 7083h	ICU	Interrupt request register 131	IR131	8	8	2	ICLK	
0008 7084h	ICU	Interrupt request register 132	IR132	8	8	2	ICLK	
0008 7085h	ICU	Interrupt request register 133	IR133	8	8	2	ICLK	
0008 7086h	ICU	Interrupt request register 134	IR134	8	8	2	ICLK	
0008 7087h	ICU	Interrupt request register 135	IR135	8	8	2	ICLK	
0008 7088h	ICU	Interrupt request register 136	IR136	8	8	2	ICLK	
0008 7089h	ICU	Interrupt request register 137	IR137	8	8	2	ICLK	
0008 708Ah	ICU	Interrupt request register 138	IR138	8	8	2	ICLK	
0008 708Bh	ICU	Interrupt request register 139	IR139	8	8	2	ICLK	
0008 708Ch	ICU	Interrupt request register 140	IR140	8	8	2	ICLK	
0008 708Dh	ICU	Interrupt request register 141	IR141	8	8	2	ICLK	
0008 708Eh	ICU	Interrupt request register 142	IR142	8	8	2	ICLK	
0008 708Fh	ICU	Interrupt request register 143	IR143	8	8	2	ICLK	
0008 7090h	ICU	Interrupt request register 144	IR144	8	8	2	ICLK	
0008 7091h	ICU	Interrupt request register 145	IR145	8	8	2	ICLK	
0008 7092h	ICU	Interrupt request register 146	IR146	8	8	2	ICLK	
0008 7093h	ICU	Interrupt request register 147	IR147	8	8	2	ICLK	
0008 7094h	ICU	Interrupt request register 148	IR148	8	8	2	ICLK	
0008 7095h	ICU	Interrupt request register 149	IR149	8	8	2	ICLK	

Table 4.1 List of I/O Registers (Address Order) (32/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 C114h	MPC	USB0 control register	PFUSB0	8	8	2, 3 PCLKB	2 ICLK	MPC
0008 C115h	MPC	USB1 control register	PFUSB1	8	8	2, 3 PCLKB	2 ICLK	
0008 C11Fh	MPC	Write-protect register	PWPR	8	8	2, 3 PCLKB	2 ICLK	
0008 C120h	PORT	Port switching register B	PSRB	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C121h	PORT	Port switching register A	PSRA	8	8	2, 3 PCLKB	2 ICLK	
0008 C140h	MPC	P00 pin function control register	P00PFS	8	8	2, 3 PCLKB	2 ICLK	MPC
0008 C141h	MPC	P01 pin function control register	P01PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C142h	MPC	P02 pin function control register	P02PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C143h	MPC	P03 pin function control register	P03PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C145h	MPC	P05 pin function control register	P05PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C147h	MPC	P07 pin function control register	P07PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C148h	MPC	P10 pin function control register	P10PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C149h	MPC	P11 pin function control register	P11PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C14Ah	MPC	P12 pin function control register	P12PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C14Bh	MPC	P13 pin function control register	P13PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C14Ch	MPC	P14 pin function control register	P14PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C14Dh	MPC	P15 pin function control register	P15PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C14Eh	MPC	P16 pin function control register	P16PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C14Fh	MPC	P17 pin function control register	P17PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C150h	MPC	P20 pin function control register	P20PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C151h	MPC	P21 pin function control register	P21PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C152h	MPC	P22 pin function control register	P22PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C153h	MPC	P23 pin function control register	P23PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C154h	MPC	P24 pin function control register	P24PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C155h	MPC	P25 pin function control register	P25PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C156h	MPC	P26 pin function control register	P26PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C157h	MPC	P27 pin function control register	P27PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C158h	MPC	P30 pin function control register	P30PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C159h	MPC	P31 pin function control register	P31PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C15Ah	MPC	P32 pin function control register	P32PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C15Bh	MPC	P33 pin function control register	P33PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C15Ch	MPC	P34 pin function control register	P34PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C160h	MPC	P40 pin function control register	P40PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C161h	MPC	P41 pin function control register	P41PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C162h	MPC	P42 pin function control register	P42PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C163h	MPC	P43 pin function control register	P43PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C164h	MPC	P44 pin function control register	P44PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C165h	MPC	P45 pin function control register	P45PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C166h	MPC	P46 pin function control register	P46PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C167h	MPC	P47 pin function control register	P47PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C168h	MPC	P50 pin function control register	P50PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C169h	MPC	P51 pin function control register	P51PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C16Ah	MPC	P52 pin function control register	P52PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C16Ch	MPC	P54 pin function control register	P54PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C16Dh	MPC	P55 pin function control register	P55PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C16Eh	MPC	P56 pin function control register	P56PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C16Fh	MPC	P57 pin function control register	P57PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C170h	MPC	P60 pin function control register	P60PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C171h	MPC	P61 pin function control register	P61PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C176h	MPC	P66 pin function control register	P66PFS	8	8	2, 3 PCLKB	2 ICLK	
0008 C177h	MPC	P67 pin function control register	P67PFS	8	8	2, 3 PCLKB	2 ICLK	

Table 5.4 DC Characteristics (3) (for D and G Versions (-40 ≤ Ta ≤ +85°C))

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, T_a = T_{opr}

Item				Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Supply current*1	High-speed operating mode	Max.*2		I _{CC} *3	—	—	100	mA	ICLK = 100 MHz PCLKA = 100MHz PCLKB = 50 MHz FCLK = 50 MHz BCLK = 100MHz	
		Normal*4	Peripheral function: clock signal supplied*4		—	52	—			
			Peripheral function: clock signal stopped*4		—	40	—			
		Sleep mode			—	25	65			
		All-module-clock-stop mode (reference value)			—	20	38			
		Increased by BGO operation*5			—	15	—			
	Low-speed operating mode 1*6				—	4	—			ICLK = 1 MHz
	Low-speed operating mode 2				—	1	—			
	Software standby mode				—	0.2	6			
	Deep software standby mode	Power supplied to RAM and USB resume detecting unit			—	22	200			μA
		Power not supplied to RAM and USB resume detecting unit	Power-on reset circuit and low-power consumption function disabled	—	21	60				
			Power-on reset circuit and low-power	—	6.2	28				
		Increase when the RTC is operating	When a crystal oscillator for low clock loads is in use	—	1.0	—				
			When a crystal oscillator for standard clock loads is in use	—	3.0	—				
		RTC operating while VCC is off (with the battery backup function, only the RTC and sub-clock oscillator operate)	When a crystal oscillator for low clock loads is in use	—	0.9	—	V _{BATT} = 2.0 V, VCC = 0V			
	When a crystal oscillator for standard clock loads is in use		—	1.6	—	V _{BATT} = 3.3 V, VCC = 0V				
			—	1.7	—	V _{BATT} = 2.0 V(for products with 100 pins or more), VBATT = 2.3 V (for the 64-pin product), VCC = 0V				
			—	3.3	—	V _{BATT} = 3.3 V, VCC = 0V				
	Analog power supply current*7	During 12-bit A/D conversion (including temperature sensor)			I _{AVCC0}	—	2.3	3.2	mA	
		During 10-bit A/D conversion			I _{VREFH} *9	—	1.0	1.65		mA
During D/A conversion (per unit)			—	0.7		1.0	mA			
Waiting for A/D, D/A conversion (all units)*10			—	—	25	35		μA		
A/D, D/A converter in standby mode (all units)*10				—	0.1	4.0	μA			
Reference power supply current	During 12-bit A/D conversion			I _{VREFH0}	—	0.6		0.7	mA	
	Waiting for 12-bit A/D conversion (per unit)				—	0.5	0.6	mA		
	12-bit A/D converter in standby mode (per unit)				—	0.1	2.0			μA

Table 5.6 DC Characteristics (4)

Conditions: $V_{CC} = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$,
 $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Permissible total power consumption*1	P_d	—	—	380	mW	*2

Note 1. This is the total power consumption of the chip as a whole (including the power consumed by the output buffers).

Note 2. Contact a Renesas sales office or agent regarding further details of the conditions of measurement.

Table 5.7 Permissible Output Currents

Conditions: $V_{CC} = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$,
 $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V, $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit
Permissible output low current (average value per pin)	All output pins*1	Normal drive	I_{OL}	—	—	2.0	mA
	All output pins*2	High drive	I_{OL}			3.8	mA
Permissible output low current (max. value per pin)	All output pins*1	Normal drive	I_{OL}	—	—	4.0	mA
	All output pins*2	High drive	I_{OL}			7.6	mA
Permissible output low current (total)	Total of all output pins		ΣI_{OL}	—	—	80	mA
Permissible output high current (average value per pin)	All output pins*1	Normal drive	I_{OH}	—	—	−2.0	mA
	USB_DPUPE pin*2	High drive	I_{OH}	—	—	−3.8	mA
Permissible output high current (max. value per pin)	All output pins*1	Normal drive	I_{OH}	—	—	−4.0	mA
	All output pins*2	High drive	I_{OH}	—	—	−7.6	mA
Permissible output high current (total)	Total of all output pins		ΣI_{OH}	—	—	−80	mA

Caution: To protect the LSI's reliability, the output current values should not exceed the values in this table.

Note 1. This is the value when normal driving ability is set with a pin for which normal driving ability is selectable.

Note 2. This is the value when high driving ability is set with a pin for which normal driving ability is selectable or the value of the pin to which high driving ability is fixed.

Table 5.17 Bus Timing (packages with 100 pins or less)

Conditions: $V_{CC} = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$,

$VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V,

$ICLK = 8$ to 100 MHz, $BCLK$ pin = 8 to 50 MHz, $T_a = T_{opr}$

Output load conditions: $V_{OH} = VCC \times 0.5$, $V_{OL} = VCC \times 0.5$, $I_{OH} = -1.0$ mA, $I_{OL} = 1.0$ mA, $C = 30$ pF

High drive output is selected by the drive capacity control register.

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	20	ns	Figure 5.17 to Figure 5.22
Byte control delay time	t_{BCD}	—	20	ns	
CS# delay time	t_{CSD}	—	20	ns	
ALE delay time	t_{ALED}	—	20	ns	
RD# delay time	t_{RSD}	—	20	ns	
Read data setup time	t_{RDS}	15	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	20	ns	
Write data delay time	t_{WDD}	—	20	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	15	—	ns	Figure 5.23
WAIT# hold time	t_{WTH}	0	—	ns	

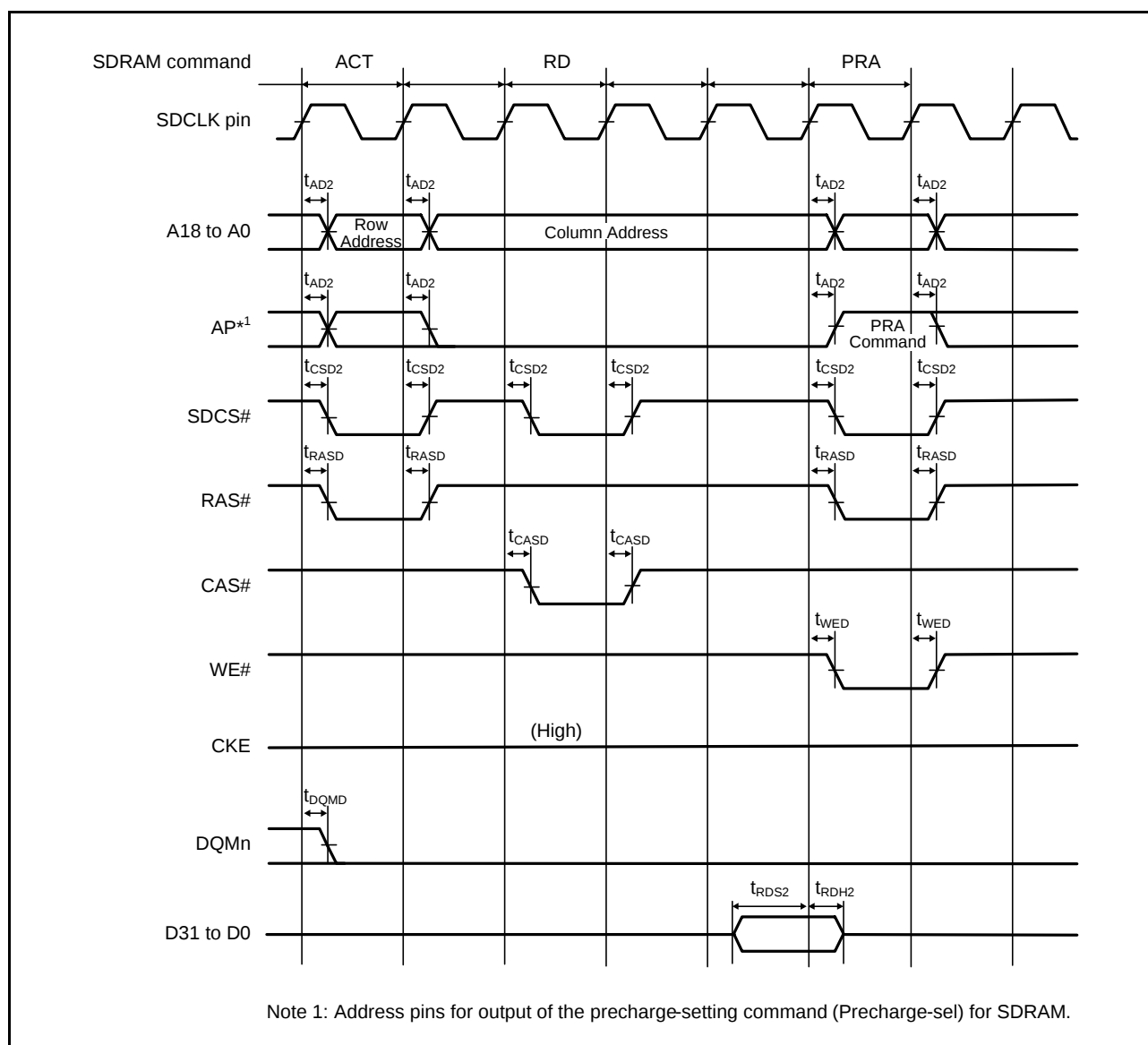


Figure 5.24 SDRAM Space Single Read Bus Timing

5.5 A/D Conversion Characteristics

Table 5.28 10-Bit A/D Conversion CharacteristicsConditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to AV_{CC0} $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V $PCLK = 8$ to 50 MHz $T_a = T_{opr}$

Item			Min.	Typ.	Max.	Unit	Test Conditions
Resolution			—	—	10	Bit	
Conversion time*1 (Operation at PCLK = 50 MHz)	With 0.1-μF external capacitor	When the capacitor is charged enough*2	3.0 (2.5)*3	—	—	μs	Sampling in 125 states
	Without 0.1-μF external capacitor	Permissible signal source impedance (max.) = 1.0 kΩ, VCC ≥ 3.0 V	1.5 (1.0)*3	—	—		Sampling in 50 states
		Permissible signal source impedance (max.) = 1.0 kΩ, VCC ≥ 2.7 V	3.5 (3.0)*3	—	—		Sampling in 150 states
		Permissible signal source impedance (max.) = 5.0 kΩ, VCC ≥ 3.0 V	2.0 (1.5)*3	—	—		Sampling in 75 states
		Permissible signal source impedance (max.) = 5.0 kΩ, VCC ≥ 2.7 V	4.0 (3.5)*3	—	—		Sampling in 175 states
Analog input capacitance			—	—	6.0	pF	
Offset error			—	±1.5	±3.0	LSB	
Full-scale error			—	±1.5	±3.0	LSB	
Quantization error			—	±0.5	—	LSB	
Absolute accuracy			—	±1.5	±3.0	LSB	
DNL differential nonlinearity error			—	±0.5	±1.0	LSB	
INL integral nonlinearity error			—	±1.5	±3.0	LSB	

Note: The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds during A/D conversion, values may not fall within the above ranges.

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The scanning is not supported.

Note 3. The value in parentheses indicates the sampling time.

5.6 D/A Conversion Characteristics

Table 5.31 D/A Conversion Characteristics

Conditions: $VCC = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to VCC

$VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V

$T_a = T_{opr}$

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	10	10	10	Bit	
Conversion time	—	—	3.0	μ s	20-pF capacitive load
Absolute accuracy	—	± 2.0	± 4.0	LSB	2-M Ω resistive load
	—	—	± 3.0	LSB	4-M Ω resistive load
	—	—	± 2.0	LSB	10-M Ω resistive load
RO output resistance	—	3.6	—	k Ω	

5.7 Temperature Sensor Characteristics

Table 5.32 Temperature Sensor Characteristics

Conditions: $VCC = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to VCC

$VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V

$T_a = T_{opr}$

Item	Min.	Typ.	Max.	Unit	Test Conditions
Relative accuracy	—	± 1	—	$^{\circ}$ C	
Temperature slope	—	4.1	—	mV/ $^{\circ}$ C	
Output voltage (@25 $^{\circ}$ C)	—	1.26	—	V	
Temperature sensor start time	—	—	30	μ s	
Sampling time	—	—	5	μ s	

5.11 ROM (Flash Memory for Code Storage) Characteristics

Table 5.36 ROM (Flash Memory for Code Storage) Characteristics (1)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6V, VREFH0 = 2.7V to AVCC0
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0V
Temperature range for the programming/erasure operation: T_a = T_{opr}

Item	Symbol	min	typ	max	Unit	Condition
Reprogram/erase cycle*1	N _{PEC}	1000	—	—	Times	
Data hold time	t _{DRP}	30*2	—	—	Year	T _a = +85°C

Note 1. Definition of reprogram/erase cycle:

The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 256-byte programming is performed 16 times for different addresses in 4-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. The result obtained from the reliability test.

Table 5.37 ROM (Flash Memory for Code Storage) Characteristics (2)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
Temperature range for the programming/erasure operation: T_a = T_{opr}

Item		Symbol	FCLK = 4 MHz			20 MHz ≤ FCLK ≤ 50 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time N _{PEC} ≤ 100 times	128 bytes	t _{P128}	—	2.8	28	—	1	10	ms
	4 Kbytes	t _{P4K}	—	63	140	—	23	50	ms
	16 Kbytes	t _{P16K}	—	252	560	—	90	200	ms
Programming time N _{PEC} > 100 times	128 bytes	t _{P128}	—	3.4	33.6	—	1.2	12	ms
	4 Kbytes	t _{P4K}	—	75.6	168	—	27.6	60	ms
	16 Kbytes	t _{P16K}	—	302.4	672	—	108	240	ms
Erasure time N _{PEC} ≤ 100 times	4 Kbytes	t _{E4K}	—	50	120	—	25	60	ms
	16 Kbytes	t _{E16K}	—	200	480	—	100	240	ms
Erasure time N _{PEC} > 100 times	4 Kbytes	t _{E4K}	—	60	144	—	30	72	ms
	16 Kbytes	t _{E16K}	—	240	576	—	120	288	ms
Suspend delay time during programming		t _{SPD}	—	—	400	—	—	120	μs
First suspend delay time during erasure (in suspend priority mode)		t _{SESD1}	—	—	300	—	—	120	μs
Second suspend delay time during erasure (in suspend priority mode)		t _{SESD2}	—	—	1.7	—	—	1.7	ms
Suspend delay time during erasure (in erasure priority mode)		t _{SEED}	—	—	1.7	—	—	1.7	ms
FCU reset time		t _{FCUR}	35	—	—	35	—	—	μs

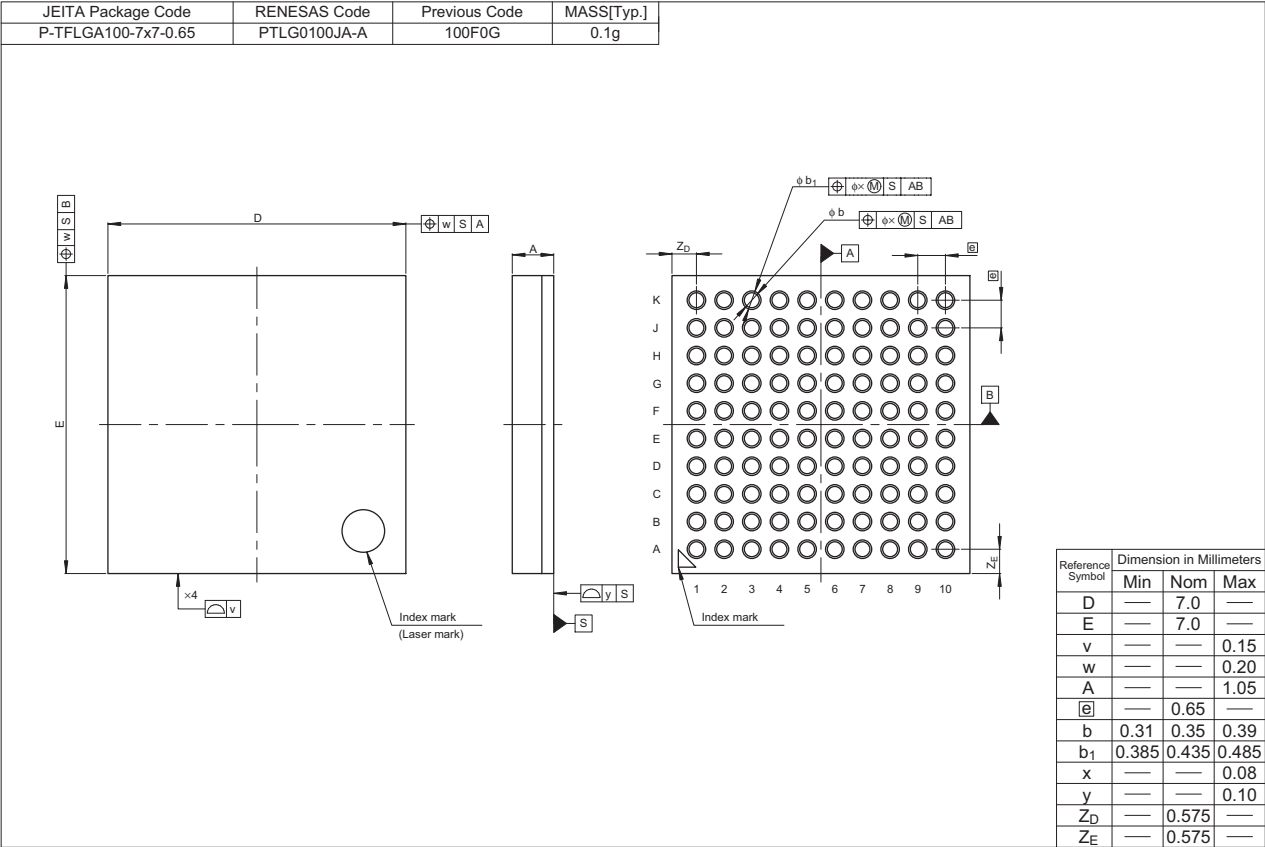


Figure F 100-pin TFLGA (PTLG0100JA-A)

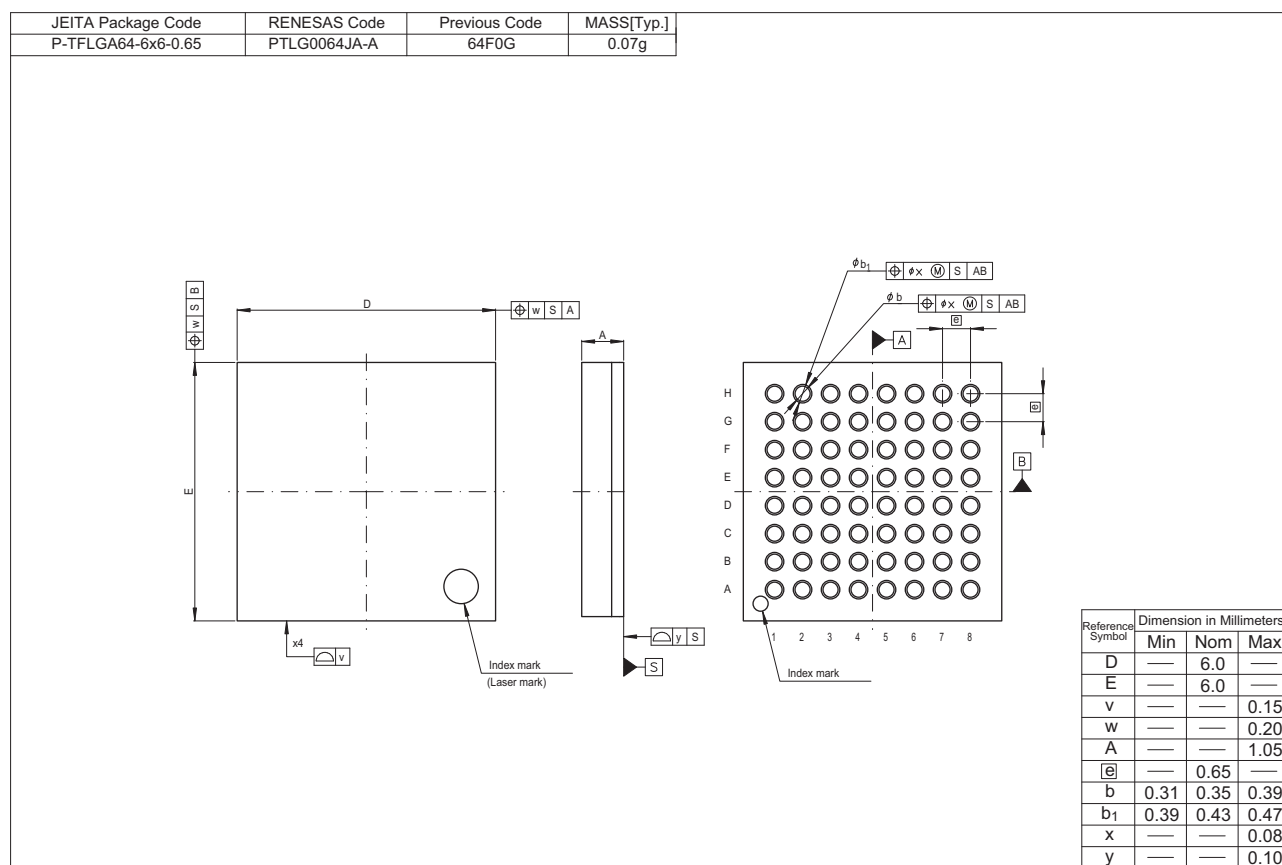


Figure H 64-pin TFLGA (PTLG0064JA-A)

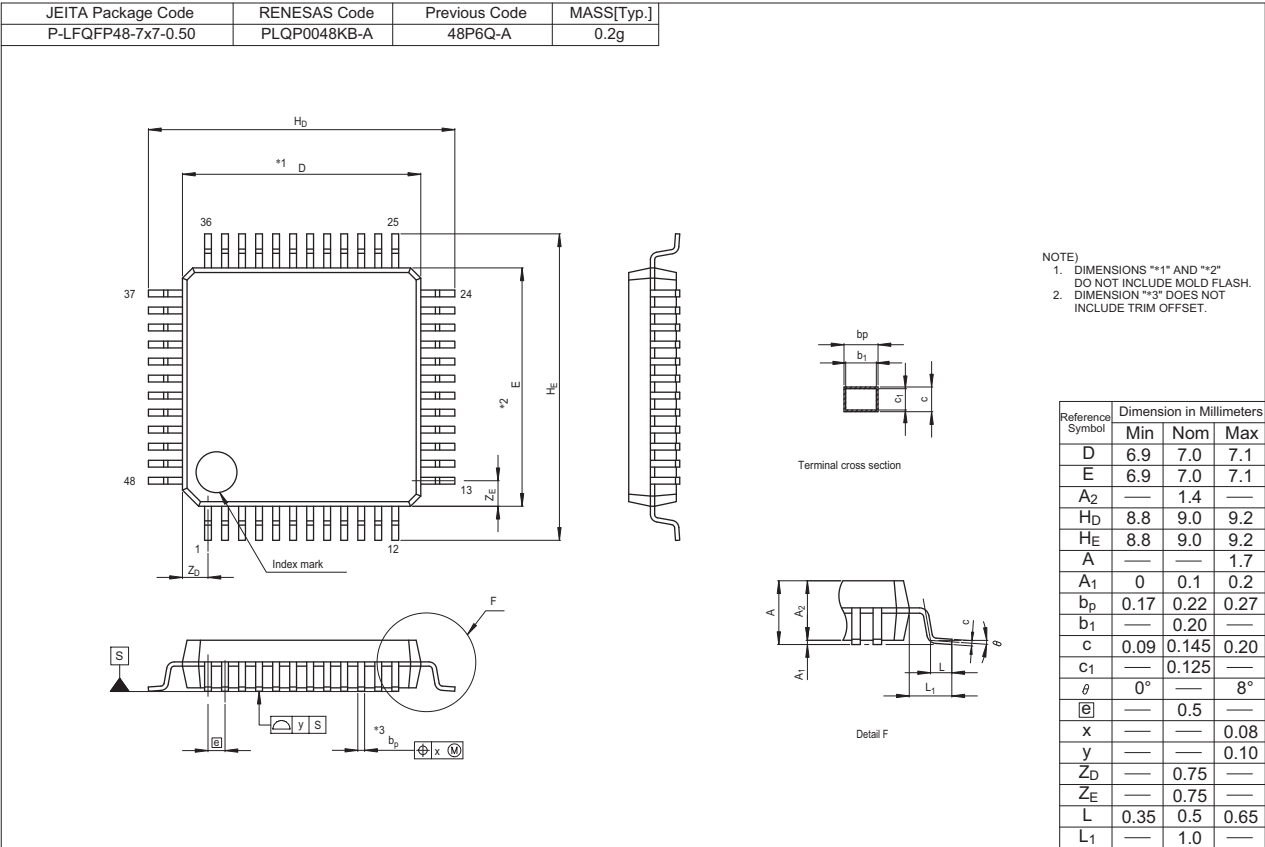


Figure J 48-pin LQFP (PLQP0048KB-A)

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.